

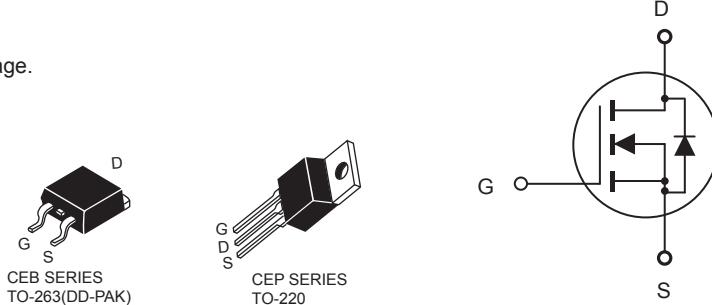


# CEP50N06G/CEB50N06G

## N-Channel Enhancement Mode Field Effect Transistor

### FEATURES

- 60V, 55A , $R_{DS(ON)} = 20m\Omega$  @ $V_{GS} = 10V$ .
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handing capability.
- RoHS compliant.
- TO-220 & TO-263 package.



### ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ C$ unless otherwise noted

| Parameter   | Symbol         | Limit       | Units     |
|---|----------------|-------------|-----------|
| Drain-Source Voltage  | $V_{DS}$       | 60          | V         |
| Gate-Source Voltage   | $V_{GS}$       | $\pm 20$    | V         |
| Drain Current-Continuous @ $T_C = 25^\circ C$                         | $I_D$          | 55          | A         |
| Drain Current-Continuous @ $T_C = 100^\circ C$                        |                | 39          | A         |
| Drain Current-Pulsed <sup>a</sup>                                     | $I_{DM}$       | 220         | A         |
| Maximum Power Dissipation @ $T_C = 25^\circ C$<br>- Derate above 25°C | $P_D$          | 131<br>0.87 | W<br>W/°C |
| Single Pulsed Avalanche Energy <sup>d</sup>                           | $E_{AS}$       | 113         | mJ        |
| Single Pulsed Avalanche Current <sup>d</sup>                          | $I_{AS}$       | 50          | A         |
| Operating and Store Temperature Range                                 | $T_J, T_{stg}$ | -55 to 175  | °C        |

### Thermal Characteristics

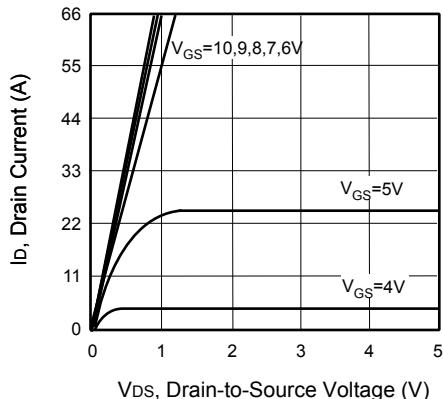
| Parameter                               | Symbol          | Limit | Units |
|---|-----------------|-------|-------|
| Thermal Resistance, Junction-to-Case    | $R_{\theta JC}$ | 1.14  | W/°C  |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 62.5  | W/°C  |



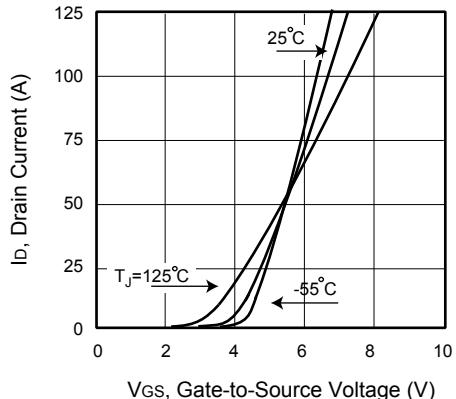
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## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

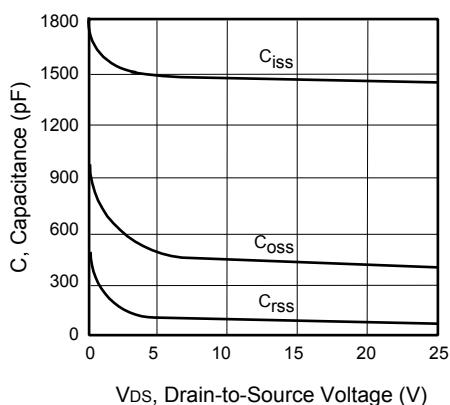
| Parameter   | Symbol                     | Test Condition  | Min | Typ  | Max  | Units            |
|---|----------------------------|---|-----|------|------|------------------|
| <b>Off Characteristics</b>  |                            |   |     |      |      |                  |
| Drain-Source Breakdown Voltage  | $\text{BV}_{\text{DSS}}$   | $V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 250\mu\text{A}$  | 60  |      |      | V                |
| Zero Gate Voltage Drain Current   | $I_{\text{DSS}}$           | $V_{\text{DS}} = 60\text{V}, V_{\text{GS}} = 0\text{V}$   |     |      | 1    | $\mu\text{A}$    |
| Gate Body Leakage Current, Forward  | $I_{\text{GSSF}}$          | $V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$   |     |      | 100  | nA               |
| Gate Body Leakage Current, Reverse  | $I_{\text{GSSR}}$          | $V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$  |     |      | -100 | nA               |
| <b>On Characteristics<sup>b</sup></b>   |                            |   |     |      |      |                  |
| Gate Threshold Voltage  | $V_{\text{GS}(\text{th})}$ | $V_{\text{GS}} = V_{\text{DS}}, I_{\text{D}} = 250\mu\text{A}$  | 2   |      | 4    | V                |
| Static Drain-Source On-Resistance   | $R_{\text{DS}(\text{on})}$ | $V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 30\text{A}$   |     | 14   | 20   | $\text{m}\Omega$ |
| <b>Dynamic Characteristics<sup>c</sup></b>  |                            |   |     |      |      |                  |
| Input Capacitance   | $C_{\text{iss}}$           | $V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$                                    |     | 1480 |      | pF               |
| Output Capacitance  | $C_{\text{oss}}$           |   |     | 385  |      | pF               |
| Reverse Transfer Capacitance  | $C_{\text{rss}}$           |   |     | 65   |      | pF               |
| <b>Switching Characteristics<sup>c</sup></b>  |                            |   |     |      |      |                  |
| Turn-On Delay Time  | $t_{\text{d}(\text{on})}$  | $V_{\text{DD}} = 30\text{V}, I_{\text{D}} = 48\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 7.5\Omega$ |     | 18   |      | ns               |
| Turn-On Rise Time   | $t_r$                      |   |     | 16   |      | ns               |
| Turn-Off Delay Time   | $t_{\text{d}(\text{off})}$ |   |     | 37   |      | ns               |
| Turn-Off Fall Time  | $t_f$                      |   |     | 17   |      | ns               |
| Total Gate Charge   | $Q_g$                      | $V_{\text{DS}} = 48\text{V}, I_{\text{D}} = 48\text{A}, V_{\text{GS}} = 10\text{V}$                             |     | 41   |      | nC               |
| Gate-Source Charge  | $Q_{\text{gs}}$            |   |     | 6    |      | nC               |
| Gate-Drain Charge   | $Q_{\text{gd}}$            |   |     | 18   |      | nC               |
| <b>Drain-Source Diode Characteristics and Maximum Ratings</b>   |                            |   |     |      |      |                  |
| Drain-Source Diode Forward Current  | $I_s$                      |   |     |      | 55   | A                |
| Drain-Source Diode Forward Voltage <sup>b</sup>   | $V_{\text{SD}}$            | $V_{\text{GS}} = 0\text{V}, I_s = 30\text{A}$   |     |      | 1.5  | V                |
| Notes :<br>a.Repetitive Rating : Pulse width limited by maximum junction temperature.<br>b.Pulse Test : Pulse Width $\leq 300\mu\text{s}$ , Duty Cycle $\leq 2\%$ .<br>c.Guaranteed by design, not subject to production testing.<br>d.L = 0.09mH, $I_{\text{AS}} = 50\text{A}$ , $V_{\text{DD}} = 24\text{V}$ , $R_G = 25\Omega$ , Starting $T_J = 25^\circ\text{C}$ |                            |   |     |      |      |                  |



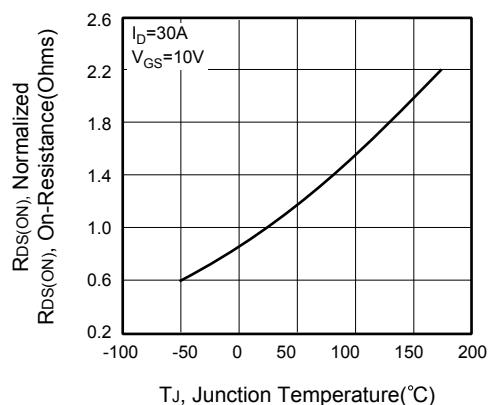
**Figure 1. Output Characteristics**



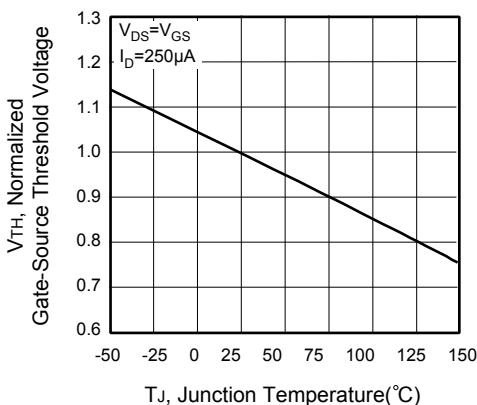
**Figure 2. Transfer Characteristics**



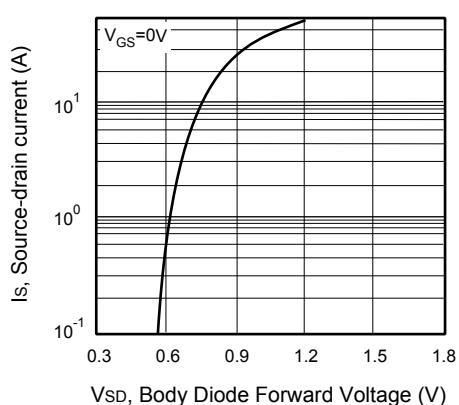
**Figure 3. Capacitance**



**Figure 4. On-Resistance Variation with Temperature**



**Figure 5. Gate Threshold Variation with Temperature**



**Figure 6. Body Diode Forward Voltage Variation with Source Current**

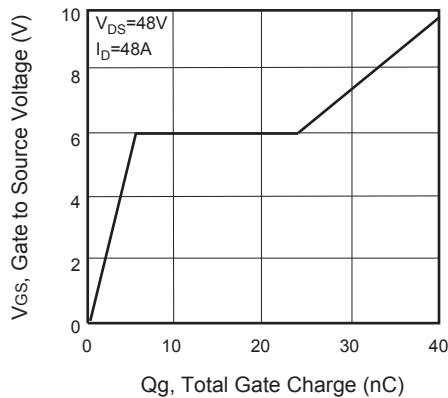


Figure 7. Gate Charge

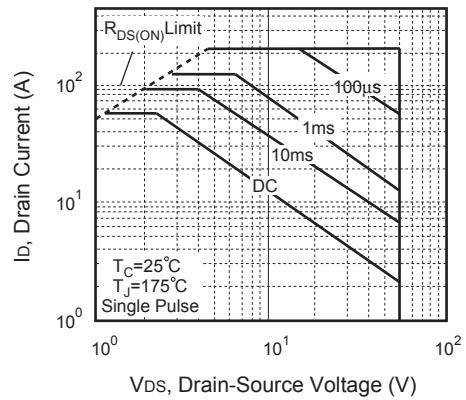


Figure 8. Maximum Safe  
Operating Area

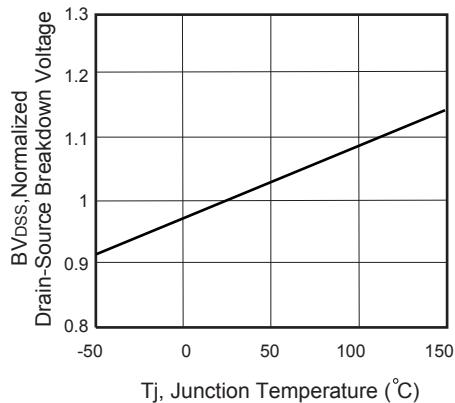


Figure 9. Breakdown Voltage Variation  
VS Temperature

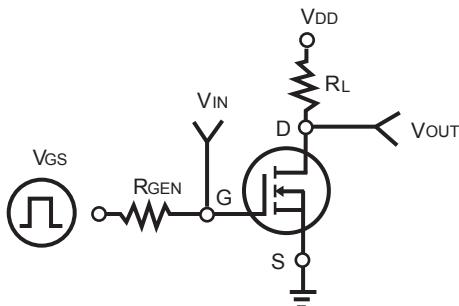


Figure 10. Switching Test Circuit

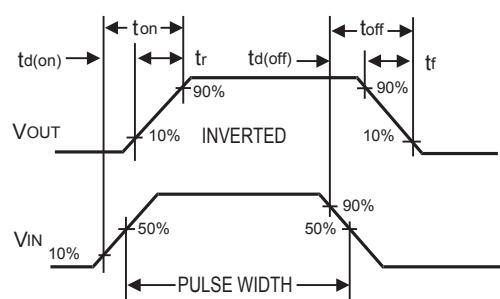


Figure 11. Switching Waveforms



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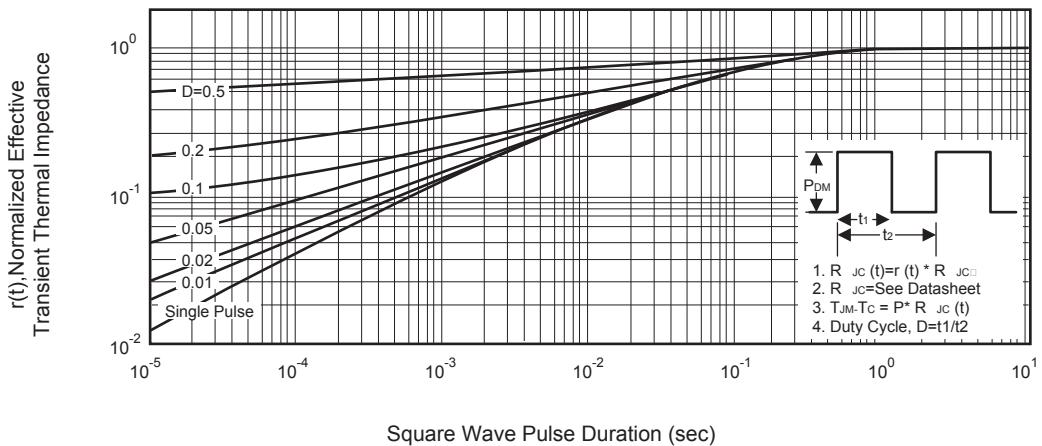


Figure 12. Normalized Thermal Transient Impedance Curve